Device Modeling Report

COMPONENTS: MOSFET (Professional Model)
PART NUMBER: 2SK4087LS
MANUFACTURER: SANYO
REMARK: Body Diode (Professional Model)

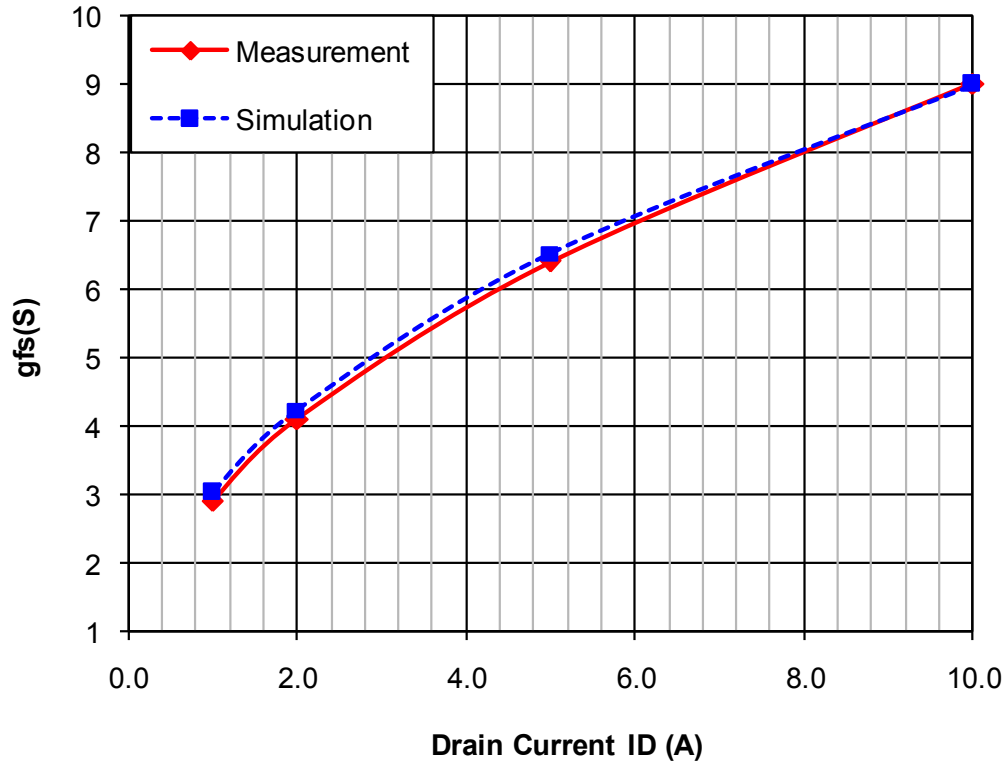
Bee Technologies Inc.

MOSFET MODEL

PSpice model parameter	Model description
LEVEL	
L	Channel Length
W	Channel Width
KP	Transconductance
RS	Source Ohmic Resistance
RD	Ohmic Drain Resistance
VTO	Zero-bias Threshold Voltage
RDS	Drain-Source Shunt Resistance
TOX	Gate Oxide Thickness
CGSO	Zero-bias Gate-Source Capacitance
CGDO	Zero-bias Gate-Drain Capacitance
CBD	Zero-bias Bulk-Drain Junction Capacitance
MJ	Bulk Junction Grading Coefficient
PB	Bulk Junction Potential
FC	Bulk Junction Forward-bias Capacitance Coefficient
RG	Gate Ohmic Resistance
IS	Bulk Junction Saturation Current
N	Bulk Junction Emission Coefficient
RB	Bulk Series Resistance
PHI	Surface Inversion Potential
GAMMA	Body-effect Parameter
DELTA	Width effect on Threshold Voltage
ETA	Static Feedback on Threshold Voltage
THETA	Mobility Modulation
KAPPA	Saturation Field Factor
VMAX	Maximum Drift Velocity of Carriers
XJ	Metallurgical Junction Depth
UO	Surface Mobility

Transconductance Characteristic

Circuit Simulation Result

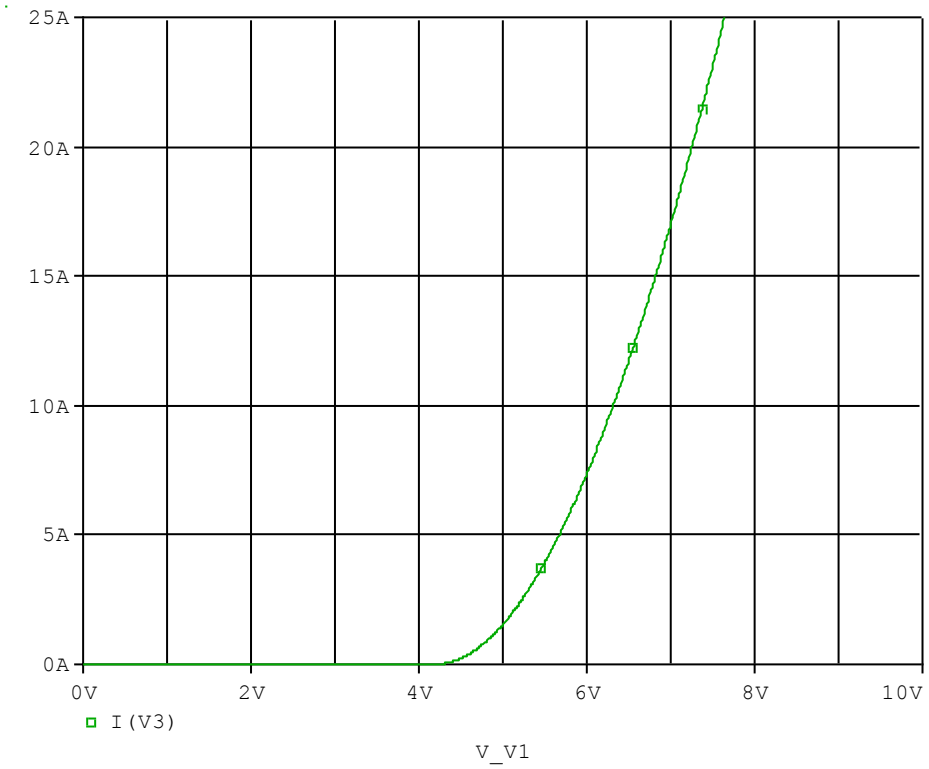


Comparison table

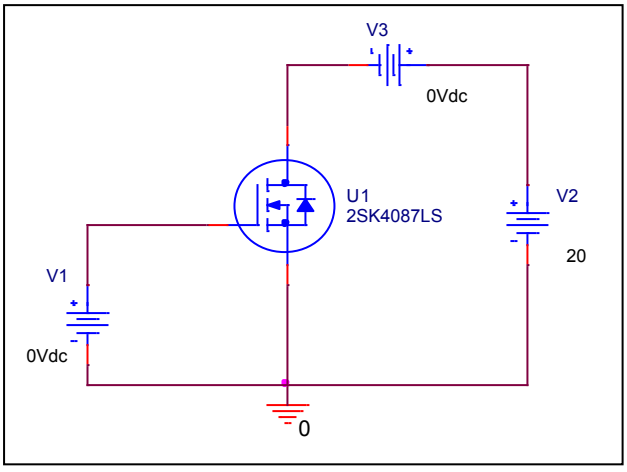
Id(A)	gfs (S)		Error (%)
	Measurement	Simulation	
1	2.900	3.028	4.42
2	4.100	4.230	3.16
5	6.400	6.527	1.99
10	9.000	8.988	-0.13

Vgs-Id Characteristic

Circuit Simulation result

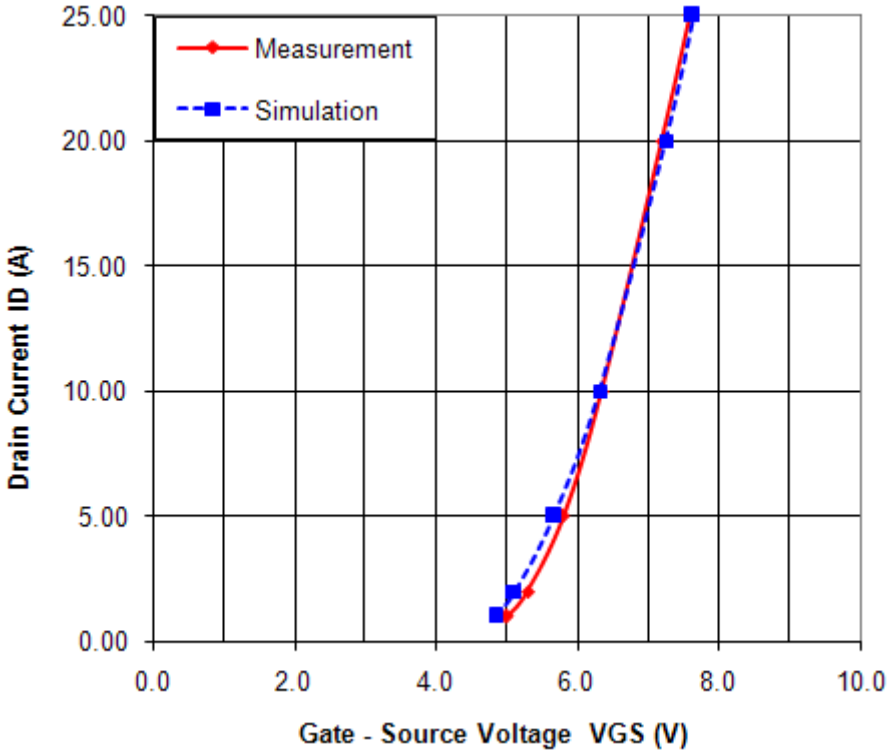


Evaluation circuit



Comparison Graph

Circuit Simulation Result

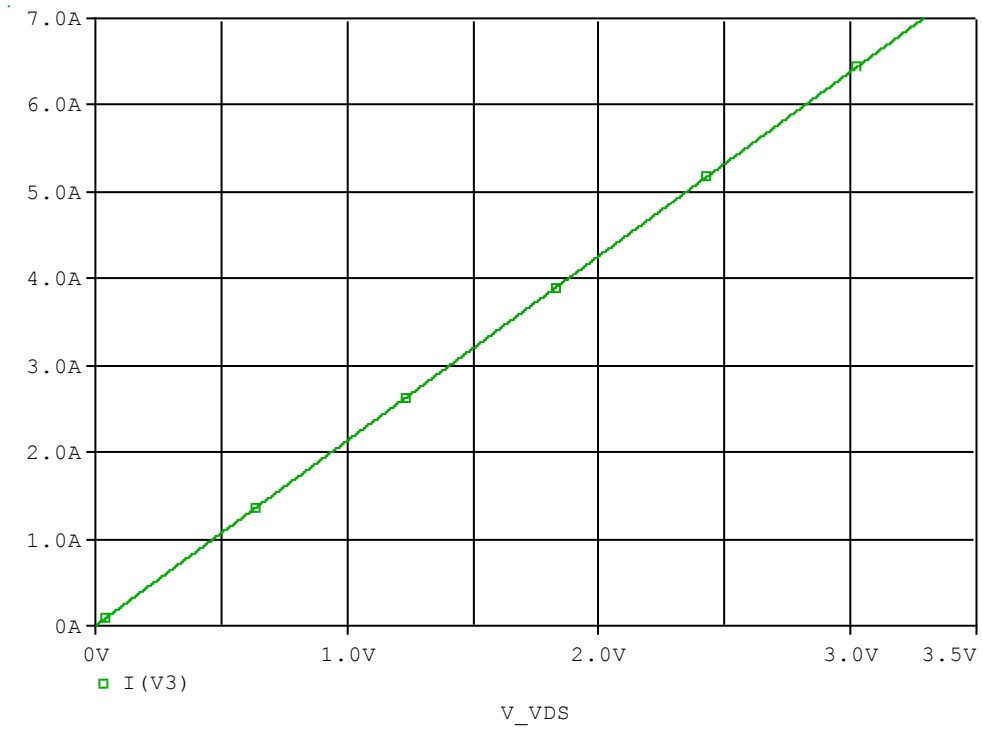


Simulation Result

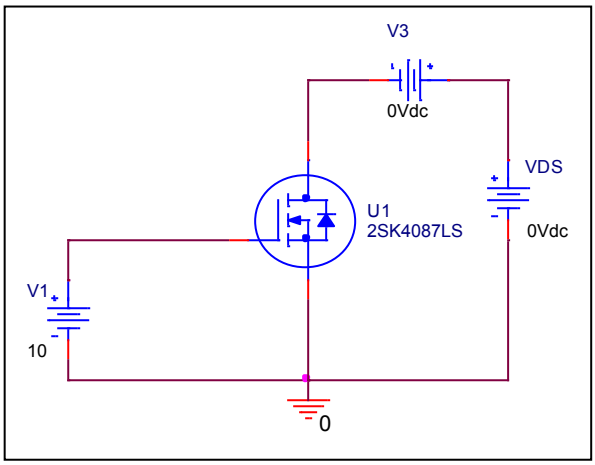
I_D(A)	V_{GS}(V)		Error (%)
	Measurement	Simulation	
1	5.000	4.840	-3.20
2	5.300	5.115	-3.49
5	5.800	5.672	-2.22
10	6.350	6.315	-0.56
20	7.200	7.254	0.74
25	7.600	7.642	0.55

Rds(on) Characteristic

Circuit Simulation result



Evaluation circuit

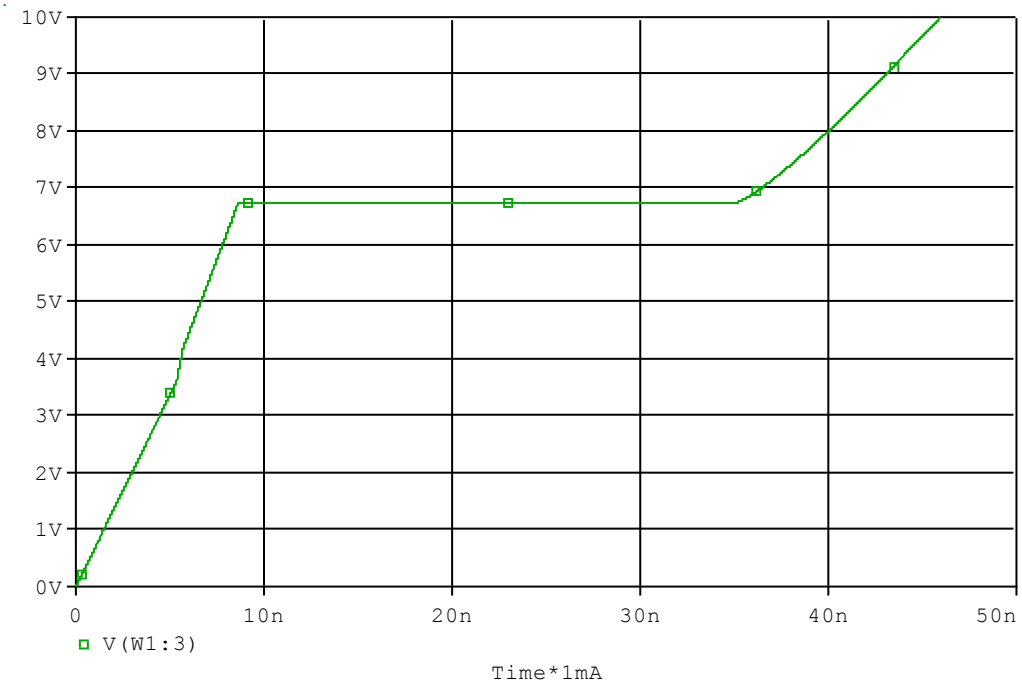


Simulation Result

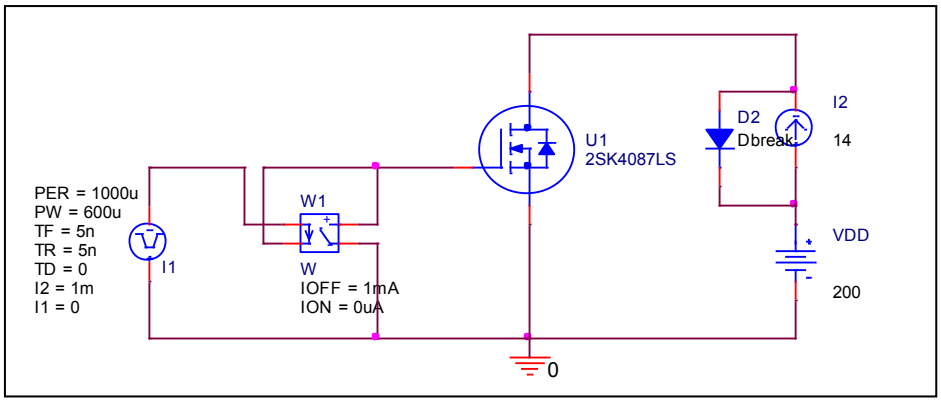
I_D = 7A, V_{GS} = 10V		Measurement	Simulation	Error (%)
R_{DS} (on)	Ω	0.4700	0.4700	0.00

Gate Charge Characteristic

Circuit Simulation result



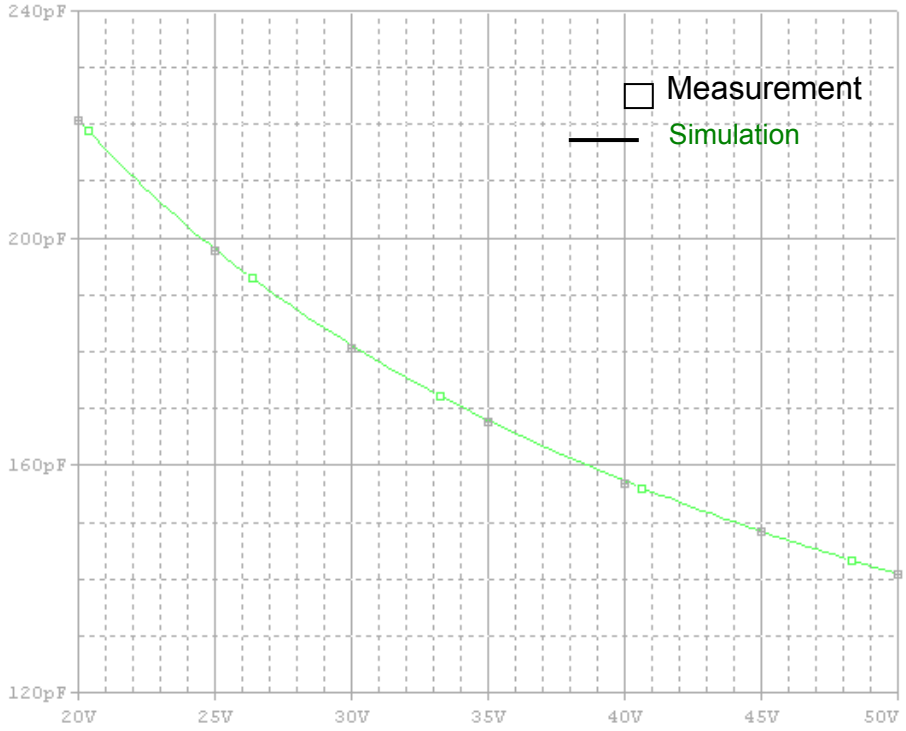
Evaluation circuit



Simulation Result

V_{DD}=200V, I_D=14A, V_{GS}=10V		Measurement	Simulation	Error (%)
Qgs	nC	8.600	8.614	0.16
Qgd	nC	26.400	26.342	-0.22
Qg	nC	46.000	45.955	-0.10

Capacitance Characteristic

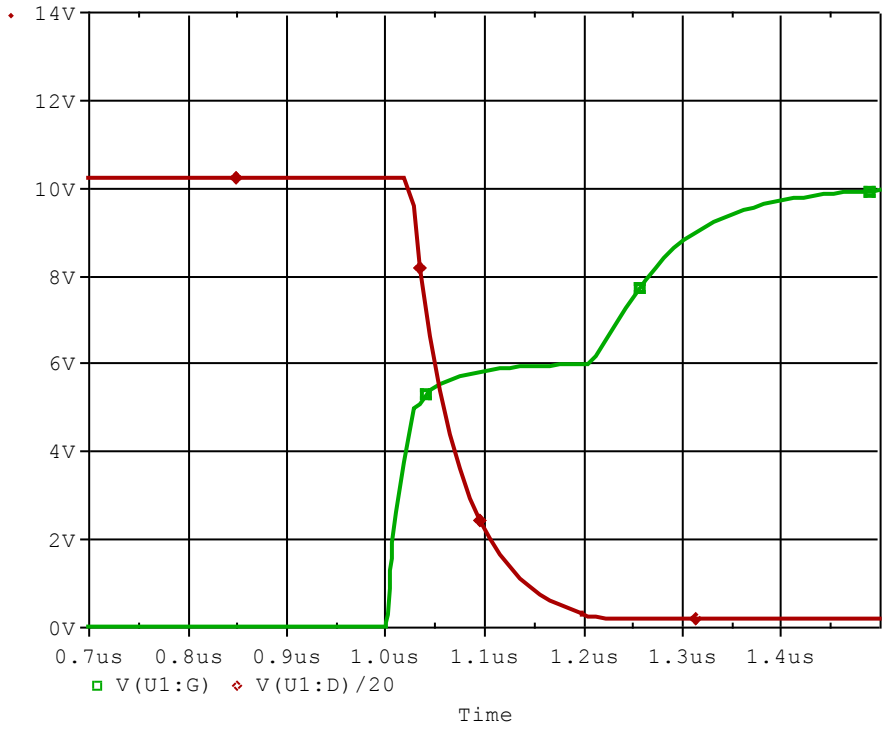


Simulation Result

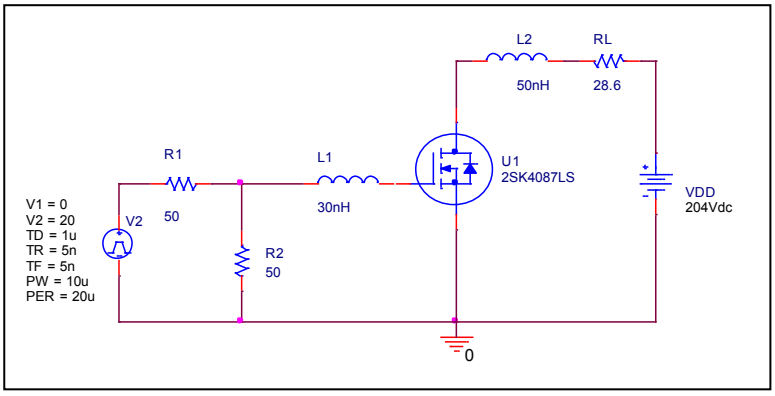
V_{DS} (V)	Cbd (pF)		Error (%)
	Measurement	Simulation	
20.000	221.000	220.890	-0.05
25.000	198.000	198.070	0.04
30.000	181.000	181.135	0.07
35.000	168.000	167.925	-0.04
40.000	157.000	157.245	0.16
45.000	148.500	148.380	-0.08
50.000	141.000	140.868	-0.09

Switching Time Characteristic

Circuit Simulation result



Evaluation circuit

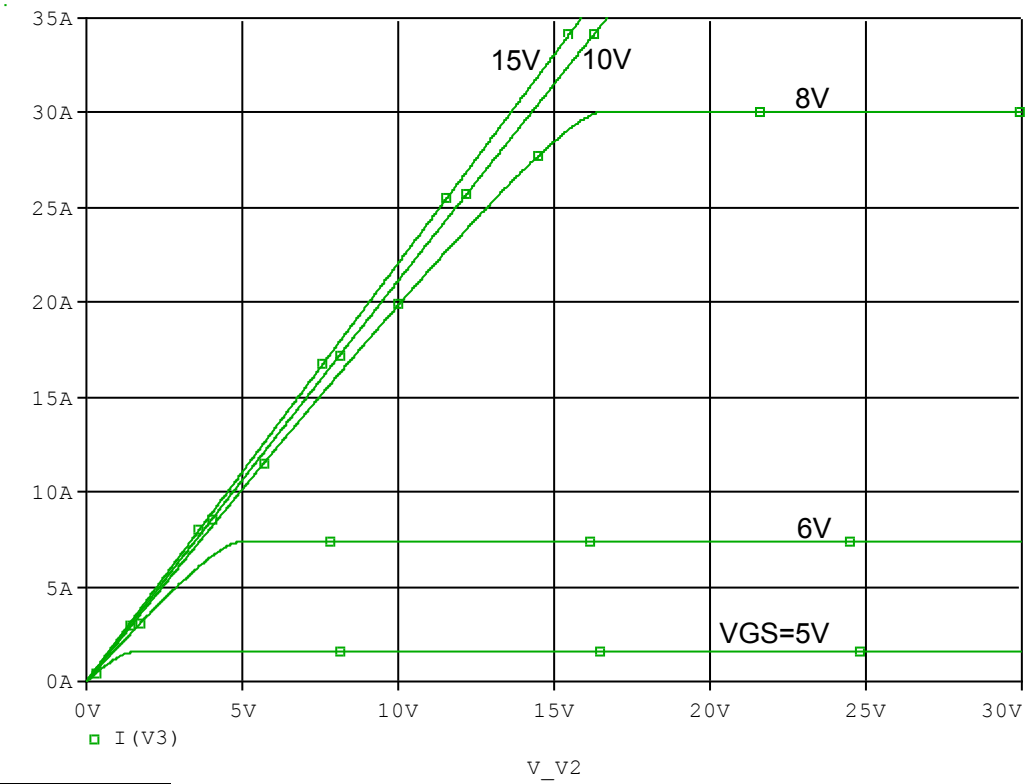


Simulation Result

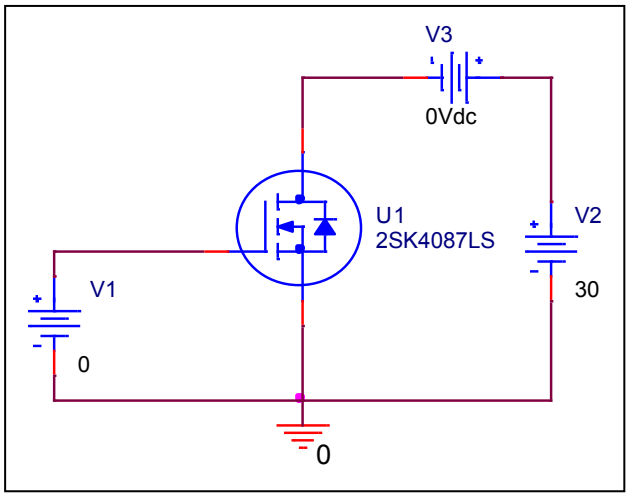
I_D=7A, V_{DD}=200V V_{GS}=0/10V		Measurement	Simulation	Error(%)
t_d(on)	ns	27.000	26.964	-0.13

Output Characteristic

Circuit Simulation result

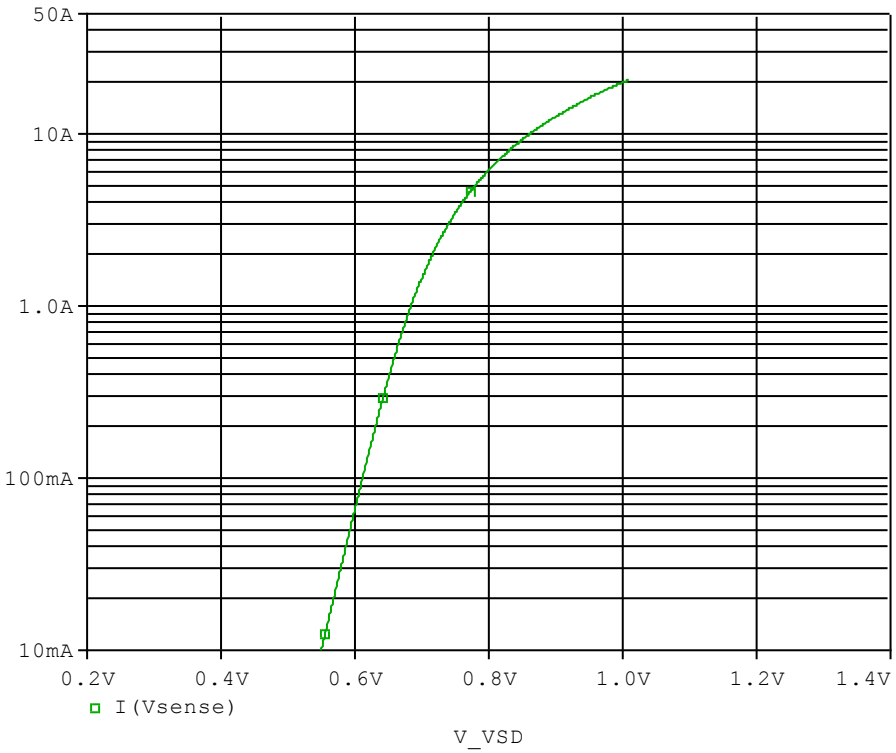


Evaluation circuit

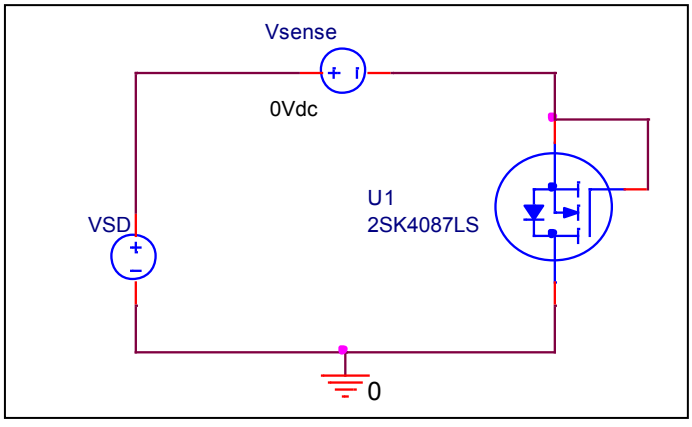


Forward Current Characteristic

Circuit Simulation Result

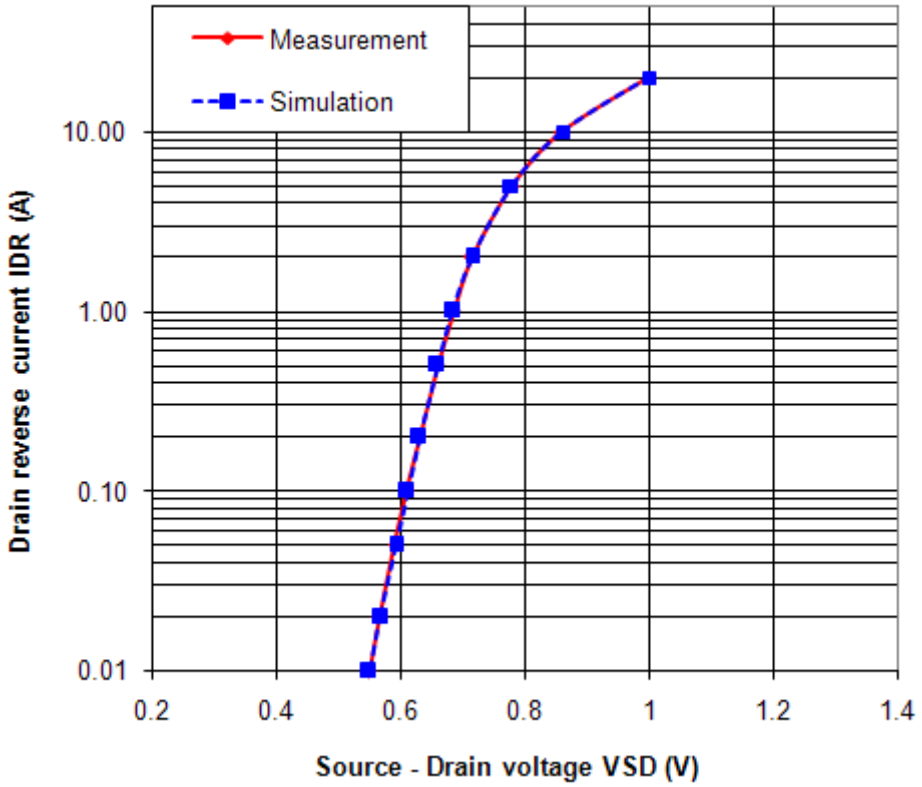


Evaluation Circuit



Comparison Graph

Circuit Simulation Result

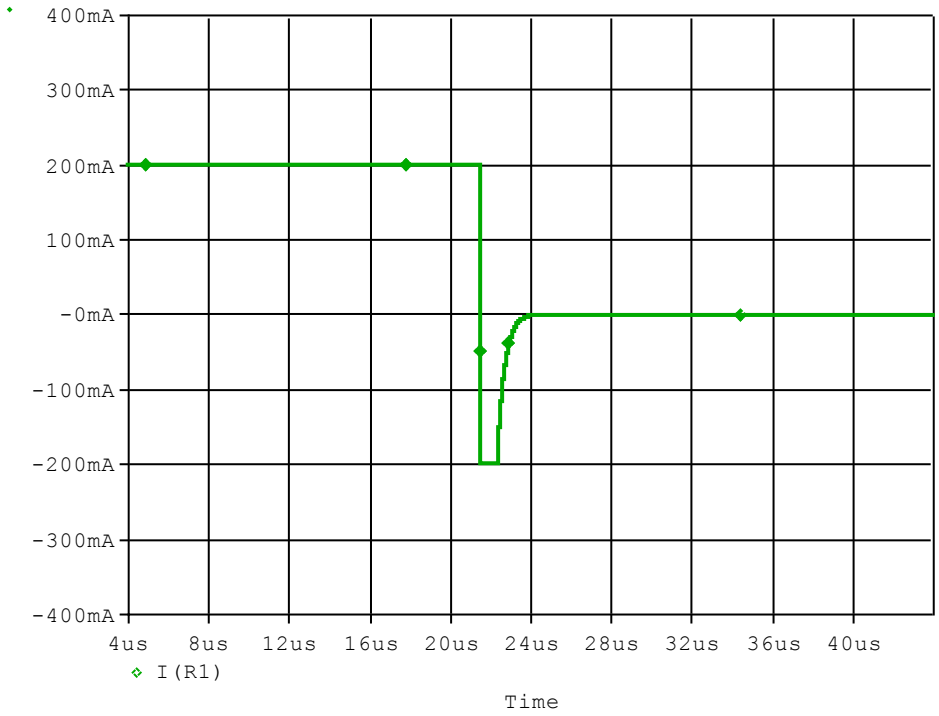


Simulation Result

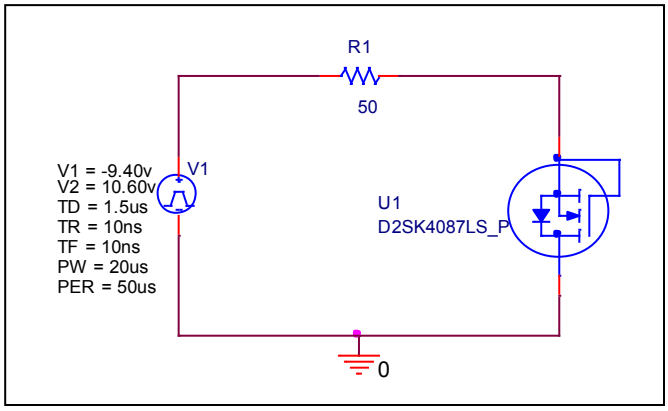
IDR(A)	VSD(V)		%Error
	Measurement	Simulation	
0.01	0.5500	0.5496	-0.08
0.02	0.5650	0.5679	0.52
0.05	0.5900	0.5924	0.41
0.1	0.6100	0.6113	0.22
0.2	0.6300	0.6309	0.15
0.5	0.6600	0.6590	-0.15
1	0.6850	0.6839	-0.15
2	0.7150	0.7155	0.07
5	0.7800	0.7791	-0.11
10	0.8600	0.8611	0.13
20	1.0000	1.0001	0.01

Reverse Recovery Characteristics

Circuit Simulation Result



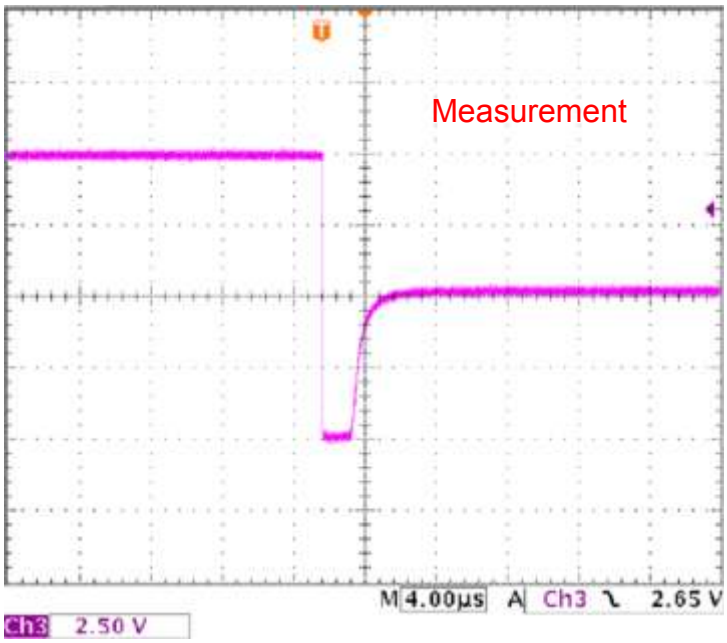
Evaluation Circuit



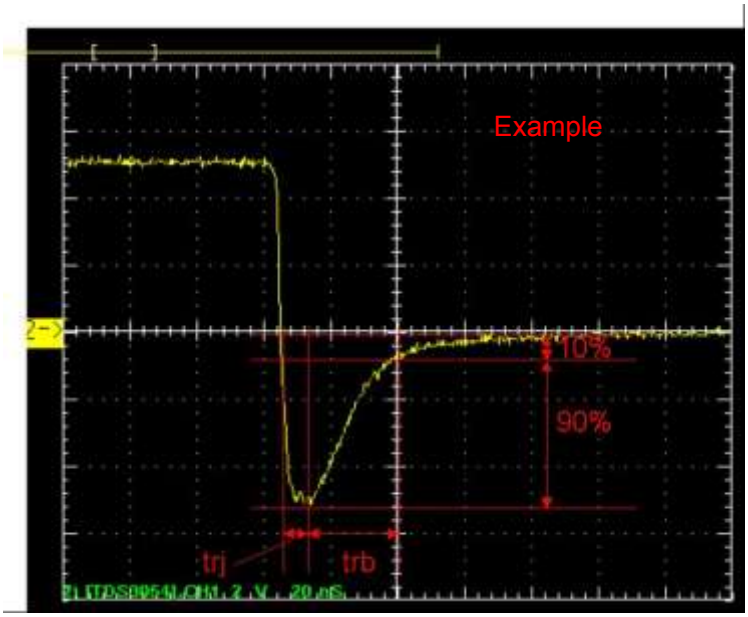
Compare Measurement vs. Simulation

		Measurement	Simulation	Error (%)
trj	**ns**	**800.000**	**800.304**	**0.04**
trb	**ns**	**880.000**	**881.307**	**0.15**
trr	**ns**	**1680.000**	**1681.611**	**0.10**

Reverse Recovery Characteristic Reference



Trj=800(ns)
Trb=880(ns)
Conditions:Ifwd=Irev=0.2(A),Rl=50



Relation between trj and trb